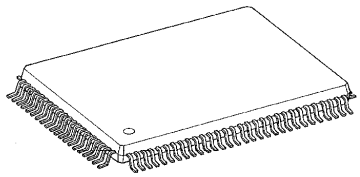
TOSHIBA CMOS DIGITAL INTEGRATED CIRCUIT SILICON MONOLITHIC

TC9263AF

CD SINGLE-CHIP PROCESSOR

The TC9263AF is a single chip processor for sync separation protection / synchronization, EFM demodulation, error correction / interpolation, microcomputer interface, CLV servo and focus tracking servo in CD player system.
In combination with the TA8190F / TA8191F / TA2031F / TA2035F / TA2065F, which are focus tracking servo LSI, a CD player system can be composed very simply.



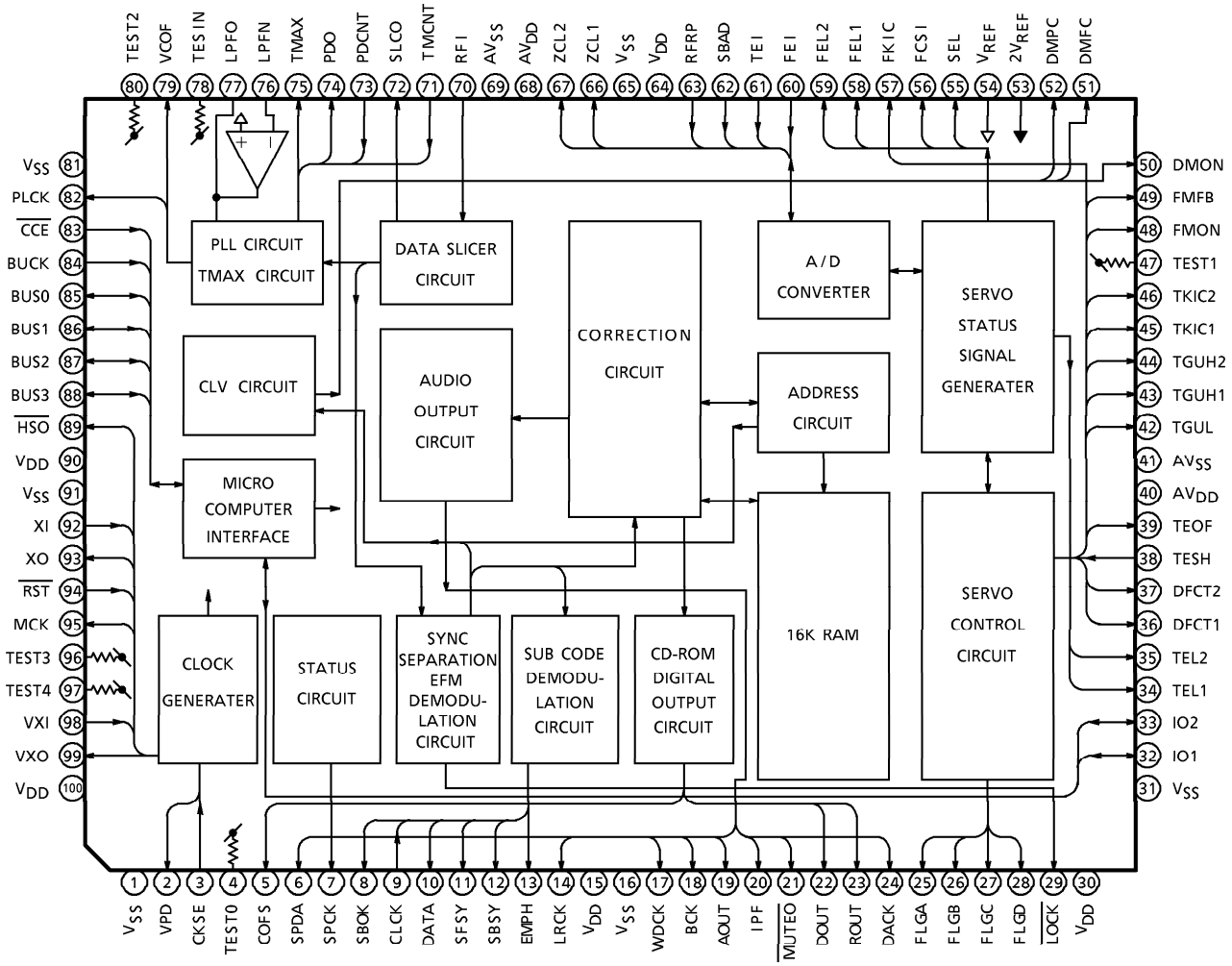
QFP100-P-1420-0.65

Weight : 1.6g (Typ.)

FEATURES

- Sync pattern detection, sync signal protection and synchronization can be made correctly.
- Built-in EFM demodulation and subcode demodulation circuit.
- Has the correction capacity of double and triple correction for C_1 and C_2 each correcting units, respectively, using C IRC correction theoretical format.
- Jitter absorbing capacity of ±6 frames.
- Built-in 16K RAM.
- Built-in Digital out circuit.
- Built-in variable pitch control circuit.
- Built-in digital level meter and peak meter circuit.
- The output circuit of each channel (Left / Right) has the independent digital attenuation circuit.
- Audio-out circuit is apply to bilingual output.
- Read timing free subcode Q data.
- Built-in the output circuit for CD-ROM (CD-I).
- Built-in data slicer and analog PLL (free-adjustment VCO adopted) circuit.
- Focus / Tracking loop gain auto adjusting function incorporated.
- Built-in AFC and APC circuit for disc motor CLV servo.
- Built-in focus tracking servo control circuit.
- Tracking search control apply to all modes.
- Double speed play is possible.
- Built-in microcomputer interface circuit.
- In CMOS structure, high speed and low power dissipation.
- 100 pin flat package.

BLOCK DIAGRAM (TOP VIEW)



FUNCTION OF EACH PIN

PIN No.	SYMBOL	I / O	FUNCTIONAL DESCRIPTION	REMARK
1	V_{SS}	—	Digital ground terminal.	—
2	VPD	O	Phase compare (XI and VXI signal) output terminal for vanable-pitch.	3-state output (V_{DD}, HiZ, V_{SS})
3	CKSE	I	Internal clock selection terminal.	—
4	TEST0	I	Test terminal. Normally, keep at "H" level or open.	With pull-up resistor
5	COFS	O	Correction system frame periodic signal output terminal. 7.35kHz	—
6	SPDA	O	Processor status signal output terminal.	—
7	SPCK	O	Processor status signal read clock output terminal. 176.4kHz	—
8	SBOK	O	Subcode Q data CRC checking result output terminal. The checking result is OK at "H" level.	—
9	CLCK	I	Subcode P-W data readout clock input terminal.	—
10	DATA	O	Subcode P-W data output terminal.	—
11	SFSY	O	Play-back frame periodic signal output terminal.	—
12	SBSY	O	Subcode block sync signal output terminal. The subcode sync is detect, output "H" level at S1 position.	—
13	EMPH	O	Subcode Q data emphasis status signal output terminal. Emphasis ON at "H" level, OFF at "L" level. Output polarity can change by command.	—
14	LRCK	O	Channel clock output terminal. Normally, 44.1kHz. Output L-channel at "L" level, R-channel at "H" level. Output polarity can change by command.	—
15	V_{DD}	—	Digital power supply voltage terminal. (+5V)	—
16	V_{SS}	—	Digital ground terminal.	—
17	WDCK	O	Word clock output terminal. Normally, 88.2kHz.	—
18	BCK	O	Bit clock output terminal. Normally, 1.4112MHz.	—
19	AOUT	O	Audio data output terminal.	—
20	IPF	O	Interpolation status signal output terminal. Output "H" level at C2 correcting unit unable error correction.	—
21	$\overline{\text{MUTEO}}$	O	Audio mute signal output terminal. Mute ON at "L" level.	—
22	DOUT	O	Digital data output terminal.	—
23	ROUT	O	Digital data for CD-ROM output terminal.	—
24	DACK	O	ROUT signal read clock output terminal. It is possible to select 2.8MHz or 5.6MHz by command.	—
25	FLGA	O	Internal status monitor terminal. It is possible to select TEZC, $\overline{\text{FOON}}$, $\overline{\text{FOK}}$, RFZC signal by command.	—
26	FLGB	O	Internal status monitor terminal. It is possible to select $\overline{\text{TRON}}$, $\overline{\text{FOON}}$, $\overline{\text{FDON}}$, RFZC signal by command.	—

PIN No.	SYMBOL	I / O	FUNCTIONAL DESCRIPTION	REMARK
27	FLGC	O	Internal status monitor terminal. It is possible to select $\overline{\text{TRON}}$, $\overline{\text{TSSR}}$, $\overline{\text{FOK}}$, $\overline{\text{SRCH}}$ signal by command.	—
28	FLGD	O	Internal status monitor terminal. It is possible to select $\overline{\text{TRON}}$, $\overline{\text{DMON}}$, $\overline{\text{HYS}}$, $\overline{\text{SHC}}$ signal by command.	—
29	$\overline{\text{LOCK}}$	O	Lock status output terminal. If sync pattern under EFM signal cannot be detector for 17ms continuously by runway detection information, this terminal is put at "H" level.	—
30	V_{DD}	—	Digital power supply voltage terminal. (+5V)	—
31	V_{SS}	—	Digital ground terminal.	—
32	IO1	I / O	Command controllable I / O port terminals.	—
33	IO2			
34	TEL1	O	Tracking gain adjusting analog switch output terminals. V_{REF} or HiZ. It is possible to select Normally mode or Command control mode.	—
35	TEL2			—
36	DFCT1	O	Defect (drop-out of data) detection signal output terminal. V_{REF} when defect is detected. Normally, HiZ.	—
37	DFCT2	O	Black-dot (drop-out of data) detection signal output terminal. V_{REF} when defect is detected. Normally, HiZ.	—
38	TESH	I	Tracking error signal sample holding analog switch input terminal.	Analog input
39	TEOF	O	Tracking servo operation ON / OFF analog switch output terminal. V_{REF} when the tracking servo is OFF.	Analog output
40	AV_{DD}	—	Analog power supply voltage terminal. (+5V)	—
41	AV_{SS}	—	Analog ground terminal.	—
42	TGUL	O	Tracking servo gain up analog switch output terminal. V_{REF} or HiZ. It is possible to select Normally mode or Command control mode.	—
43	TGUH1	O	Tracking servo gain up analog switch output terminals. HiZ when gain is up. Normally, V_{REF}. TGUH1 is used at normal play and TGUH2 is used at high (Double and Quadruple) speed play.	—
44	TGUH2			
45	TKIC1	O	Tracking actuator kick signal output terminal. It used NKIC, CKIC and tracking gain adjusting mode. Kicks in the outer direction at "$2V_{REF}$" level and in the inner direction at "AV_{SS}" level. Normally, HiZ.	3-state output ($2V_{REF}$, HiZ, AV_{SS})
46	TKIC2	O	Tracking actuator kick signal output terminal. It used FVKIC. It is possible to polarity change. Output signal form is PWM. (3-state $2V_{REF}$, V_{REF}, AV_{SS} at 132kHz). Normally, HiZ.	3-state output ($2V_{REF}$, HiZ, AV_{SS})
47	TEST1	I	Test terminal. Normally, keep at "H" level or open.	With pull-up resistor

<table>
<tr><th>PIN No.</th><th>SYMBOL</th><th>I / O</th><th>FUNCTIONAL DESCRIPTION</th><th>REMARK</th></tr>
<tr><td>48</td><td>FMON</td><td>O</td><td>Feed servo ON / OFF analog switch output terminal. The feed servo is ON at "HiZ" level, and OFF at "V_{REF}" level.</td><td>—</td></tr>
<tr><td>49</td><td>FMFB</td><td>O</td><td>Feed motor FWD / BWD feeding control signal output terminal. Output signal form is PWM. (3-state $2V_{REF}$, V_{REF}, AV_{SS} at 132kHz) Feed in the outer direction at "$2V_{REF}$" level and in the inner direction at "AV_{SS}" level. Normally, HiZ.</td><td>4-state output ($2V_{REF}$, V_{REF}, AV_{SS}, HiZ)</td></tr>
<tr><td>50</td><td>DMON</td><td>O</td><td>Disc motor driving circuit gain change-over analog switch output terminal. The CLV servo is OFF at "HiZ" level. It is possible to select "HiZ" or "V_{REF}" level, when CLV servo is ON.</td><td>—</td></tr>
<tr><td>51</td><td>DMFC</td><td>O</td><td>Disc motor CLV servo AFC signal output terminal.
<table>
<tr><th>OPERATION</th><th>COMMAND</th><th>DMFC OUTPUT</th></tr>
<tr><td>Motor acceleration</td><td>DMFK</td><td>"$2V_{REF}$"</td></tr>
<tr><td>CLV servo ON</td><td>DMSV</td><td>AFC Signal (PWM)</td></tr>
<tr><td>Motor deceleration</td><td>DMBK</td><td>"AV_{SS}"</td></tr>
<tr><td>CLV servo OFF</td><td>DMOFF</td><td>"V_{REF}"</td></tr>
</table></td><td>3-state output ($2V_{REF}$, V_{REF}, AV_{SS})</td></tr>
<tr><td>52</td><td>DMPC</td><td>O</td><td>Disc motor CLV servo APC signal output terminal.</td><td>3-state output ($2V_{REF}$, HiZ, AV_{SS})</td></tr>
<tr><td>53</td><td>$2V_{REF}$</td><td>—</td><td>Double times reference voltage input terminal. ($V_{REF} \times 2$)</td><td>—</td></tr>
<tr><td>54</td><td>V_{REF}</td><td>—</td><td>Reference voltage input terminal.</td><td>—</td></tr>
<tr><td>55</td><td>SEL</td><td>O</td><td>Servo mode indicating signal output terminal. It is possible to control laser-diode (LD) ON / OFF and focus servo ON / OFF.
<table>
<tr><th>SEL</th><th>LD</th><th>FOCUS SERVO</th><th>OPERATION</th></tr>
<tr><td>"AV_{SS}"</td><td>OFF</td><td>OFF</td><td>LD OFF</td></tr>
<tr><td>"HiZ"</td><td>ON</td><td>OFF</td><td>Focus search</td></tr>
<tr><td>"AV_{DD}"</td><td>ON</td><td>ON</td><td>Focus ON</td></tr>
</table></td><td>3-state output (AV_{DD}, HiZ, AV_{SS})</td></tr>
<tr><td>56</td><td>FCSI</td><td>O</td><td>Focus actuator driving signal output terminal in the focus serach adjust mode. Lens gets for away from disc at "AV_{DD}", Lens gets near disc at "AV_{SS}". Normally, "HiZ".</td><td>3-state output (AV_{DD}, HiZ, AV_{SS})</td></tr>
<tr><td>57</td><td>FKIC</td><td>O</td><td>Focus actuator driving signal output terminal in the focus gain adjust mode. Lens gets for away from disc at "AV_{DD}", Lens gets near disc at "AV_{SS}". Normally, "HiZ".</td><td>3-state output (AV_{DD}, HiZ, AV_{SS})</td></tr>
<tr><td>58</td><td>FEL1</td><td rowspan="2">O</td><td rowspan="2">Focus gain adjusting analog switch output terminals. V_{REF} or HiZ. It is possible to select Normally mode or Command control mode.</td><td rowspan="2">—</td></tr>
<tr><td>59</td><td>FEL2</td></tr>
<tr><td>60</td><td>FEI</td><td>I</td><td>Focus error signal input terminal.</td><td>Analog input</td></tr>
<tr><td>61</td><td>TEI</td><td>I</td><td>Tracking error signal input terminal.</td><td>Analog input</td></tr>
<tr><td>62</td><td>SBAD</td><td>I</td><td>Sub-beam adding signal input terminal.</td><td>Analog input</td></tr>
</table>

PIN No.	SYMBOL	I / O	FUNCTIONAL DESCRIPTION	REMARK
63	RFRP	I	RF ripple signal input terminal.	Analog input
64	V_{DD}	—	Digital power supply voltage terminal. (+5V)	—
65	V_{SS}	—	Digital ground terminal.	—
66	ZCL1	O	Focusing and tracking signal output terminal. (Internal 5 bits DAC output) Usually use for monitoring of internal signal.	Analog output
67	ZCL2	O	SBAD and RFRP signal output terminal. (Internal 5 bits DAC output) Usually use for monitoring of internal signal. (SBAD : sub-beam additional signal, RFRP : RF ripple signal)	Analog output
68	AV_{DD}	—	Analog power supply voltage terminal. (+5V)	—
69	AV_{SS}	—	Analog ground terminal.	—
70	RFI	I	RF signal input terminal.	Analog input
71	TMCNT	I	TMAX output control terminal. When input level is "L", TMAX terminal output fixes "HiZ". Normally, input level is "H".	—
72	SLCO	O	Data slice level output terminal. (Internal DAC output)	Analog output
73	PDCNT	I	PDO output control terminal. When input level is "L", PDO terminal output fixes "HiZ", Normally, input level is "H".	—
74	PDO	O	Phase comparator error signal output terminal between EFM signal and PLCK.	3-state output ($2V_{REF}$, HiZ, AV_{SS})
75	TMAX	O	TMAX signal output terminal. TMAX is frequency information of RF signal. TMAX PERIOD / TMAX OUTPUT: Longer than specified period — "AV_{SS}" Shorter than specified period — "$2V_{REF}$" Specified period — "HiZ"	3-state output ($2V_{REF}$, HiZ, AV_{SS})
76	LPFN	I	LPF amplifier negative input terminal for PLL.	Analog input
77	LPFO	O	LPF amplifier output terminal for PLL.	Analog output
78	TESIN	I	Test terminal. Normally, keep at "H" level or open.	With pull-up resistor
79	VCOF	O	VCO noise filter terminal.	—
80	TEST2	I	Test terminal. Normally, keep at "H" level or open.	With pull-up resistor
81	V_{SS}	—	Digital ground terminal.	—
82	PLCK	O	PLCK signal output terminal. It is possible to select PLCK, 17MCK (VCO), EFMS (EFM slice data), fixes "H" level by command.	—
83	$\overline{CCE}$	I	Command and data sending / receiving chip enable signal input terminal. The bus line becomes active at "L" level.	Schmitt trigger input
84	BUCK	I	Command and data sending / receiving clock input terminal.	Schmitt trigger input

PIN No.	SYMBOL	I / O	FUNCTIONAL DESCRIPTION	REMARK
85	BUS0	I / O	Command and data sending / receiving input / output terminals.	Schmitt trigger input. Open drain output, With pull-up resister
86	BUS1			
87	BUS2			
88	BUS3			
89	$\overline{HSO}$	O	High speed play monitor output terminal. Double and Quadruple speed play at "L" level. Normally, "H".	—
90	V_{DD}	—	Digital power supply voltage terminal. (+5V)	—
91	V_{SS}	—	Digital ground terminal.	—
92	XI	I	Crystal oscillator input terminal.	—
93	XO	O	Crystal oscillator output terminal.	—
94	$\overline{RST}$	I	Reset input terminal. The internal system is reset at "L" level.	With pull-up resistor
95	MCK	O	Master clock output terminal.	—
96	TEST3	I	Test terminal. Normally, keep at "H" level or open.	With pull-up resistor
97	TEST4	I	Test terminal. Normally, keep at "H" level or open.	With pull-up resistor
98	VXI	I	External VCO clock input terminal for variable-pitch.	Alanlog input
99	VXO	O	Buffer output terminal at VXI signal.	—
100	V_{DD}	—	Digital power supply voltage terminal. (+5V)	—

MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Power Supply Voltage	V_{DD}	−0.3~6.0	V
Input Voltage	V_{IN}	−0.3~V_{DD}+0.3	V
Power Dissipation	P_D	1,250	mW
Operating Temperature	T_{opr}	−35~85	°C
Storage Temperature	T_{stg}	−55~150	°C

ELECTRICAL CHARACTERISTICS

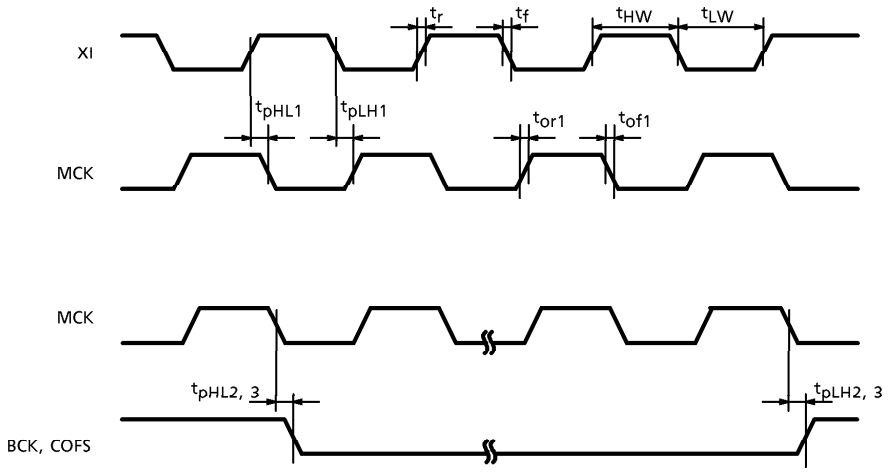
(Unless otherwise specified, V_{DD} = 5V, $2V_{REF}$ = 4.2V, V_{REF} = 2.1V, Ta = 25°C)

CHARACTERISTIC		SYMBOL	TEST CIR-CUIT	TEST CONDITION		MIN.	TYP.	MAX.	UNIT
Operating Supply Voltage		V_{DD}	—	Ta = −35~85°C		4.75	5.0	5.25	V
Operating Supply Current		I_{DD}	—	XI = 16.9344MHz, In normal mode		—	40	70	mA
Input Voltage	"H" Level	V_{IH} (1)	—	Whole input terminals except BUS0~3, BUCK and $\overline{CCE}$		3.5	—	V_{DD} + 0.3	V
	"L" Level	V_{IL} (1)				0	—	1.5	
	"H" Level	V_{IH} (2)	—	BUS0~3, BUCK, $\overline{CCE}$ (Schmitt Input)		4.0	—	V_{DD} + 0.3	
	"L" Level	V_{IL} (2)				0	—	1.0	
Input Current	"H" Level	I_{TH}	—	V_{IH} = 5V	CMOS input terminals except analog input terminal.	—	—	1.0	μA
	"L" Level	I_{TL}		V_{IL} = 0V		−1.0	—	—	
Try State Leak Current	"H" Level	I_{TLH}	—	V_{IH} = 5V		—	—	1.0	
	"L" Level	I_{TLL}		V_{IL} = 0V		−1.0	—	—	
Output Current	"H" Level	I_{OH} (1)	—	V_{OH} = 4.6V	VPD, COFS, SPDA, SPCK, SBOK, CLCK, DATA, SEL, FCSI, FKIC, PDCNT $V_{OUT} = V_{DD}$	—	—	−1.0	mA
	"L" Level	I_{OL} (1)		V_{OL} = 0.4V		2.5	—	—	
	"H" Level	I_{OH} (2)	—	V_{OH} = 4.6V	SFSY, SBSY, EMPH	—	—	−1.0	
	"L" Level	I_{OL} (2)		V_{OL} = 0.4V	$V_{OUT} = V_{DD}$	1.5	—	—	
	"H" Level	I_{OH} (3)	—	V_{OH} = 4.6V	WDCK, IPF, MUTEO, DOUT, DACK, FLGA, FLGB, FLGC, FLGD, $\overline{LOCK}$, IO1, IO2, ROUT, LRCK, BCK, AOUT, PLCK $V_{OUT} = V_{DD}$	—	—	−2.0	
	"L" Level	I_{OL} (3)		V_{OL} = 0.4V		4.0	—	—	
	"H" Level	I_{OH} (4)	—	V_{OH} = 4.6V	MCK, VXO, XO	—	—	−2.0	
	"L" Level	I_{OL} (4)		V_{OL} = 0.4V	$V_{OUT} = V_{DD}$	3.0	—	—	
	"H" Level	I_{OH} (5)	—	V_{OH} = 3.8V	TKIC1, TKIC2, FMFB, DMFC, DMPC $V_{OUT} = 2V_{REF}$	—	—	−0.4	
	"L" Level	I_{OL} (5)		V_{OL} = 0.4V		2.5	—	—	
	"H" Level	I_{OH} (6)	—	V_{OH} = 3.8V	PDO, TMAX	—	—	−1.5	
	"L" Level	I_{OL} (6)		V_{OL} = 0.4V	$V_{OUT} = 2V_{REF}$	2.5	—	—	

CHARACTERISTIC		SYMBOL	TEST CIR-CUIT	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Analog Switch OFF Current	"H" Level	I_{OFH}	—	V_{IH} = 5V	—	—	1.0	μA
	"L" Level	I_{OFL}	—	V_{IL} = 0V	− 1.0	—	—	
Analog Switch ON Resistance		R_{ON} (1)	—	FEL1, FEL2, TEL1, TEL2, FMON, TGUL, TGUH1, TGUH2, FMFB, DFCT1, DFCT2, TEOF, DMON, DMFC	—	—	0.6	kΩ
		R_{ON} (2)		TESH	—	—	1.2	
Pull-Up Resistance		R_{UP} (1)	—	$\overline{RST}$	—	65	—	kΩ
		R_{UP} (2)		$\overline{TEST}$, $\overline{TEST1}$~$\overline{5}$	—	45	—	
		R_{UP} (3)		BUS0~3	8	—	—	
Oscillation Amplifier Feedback Resistance		R_N (1)	—	XI-XO	2.0	3.5	5.0	MΩ
		R_N (2)		VXI-VXO, TESIN	0.25	0.5	1.0	
Operating Frequency Ratio		f_{OP}	—	XI	6	—	28	MHz

AC CHARACTERISTICS
(1) Clock system timing

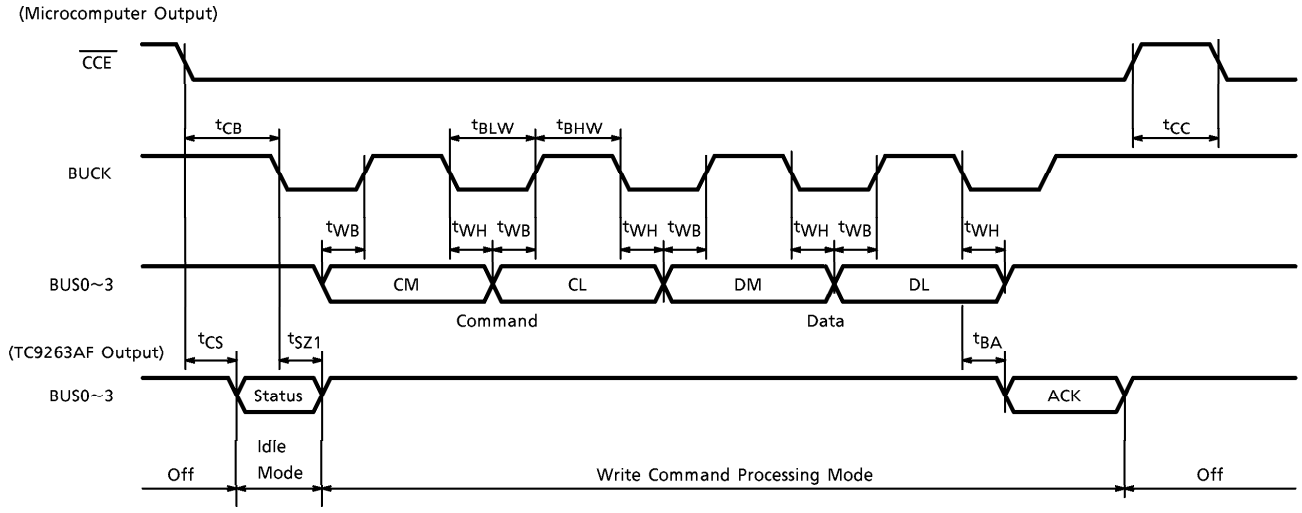
CHARACTERISTIC		SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Clock Pulse Width	"H" Level	t_{HW}	XI input	18	—	—	ns
	"L" Level	t_{LW}		18	—	—	
Input Rising Time		t_r		—	—	10	
Input Falling Time		t_f		—	—	10	
Transfer Time (1)	"H" Level	t_{pHL1}	XI→MCK	—	—	60	ns
	"L" Level	t_{pLH1}		—	—	60	
Transfer Time (2)	"H" Level	t_{pHL2}	MCK→BCK	—	—	60	
	"L" Level	t_{pLH2}		—	—	60	
Transfer Time (3)	"H" Level	t_{pHL3}	MCK→COFS	—	—	100	
	"L" Level	t_{pLH3}		—	—	100	
Output Rising Time (1)		t_{or1}	MCK, BCK	—	—	15	ns
Output Falling Time (1)		t_{of1}		—	—	15	
Output Rising Time (2)		t_{or2}	COFS	—	—	40	ns
Output Falling Time (2)		t_{of2}		—	—	40	



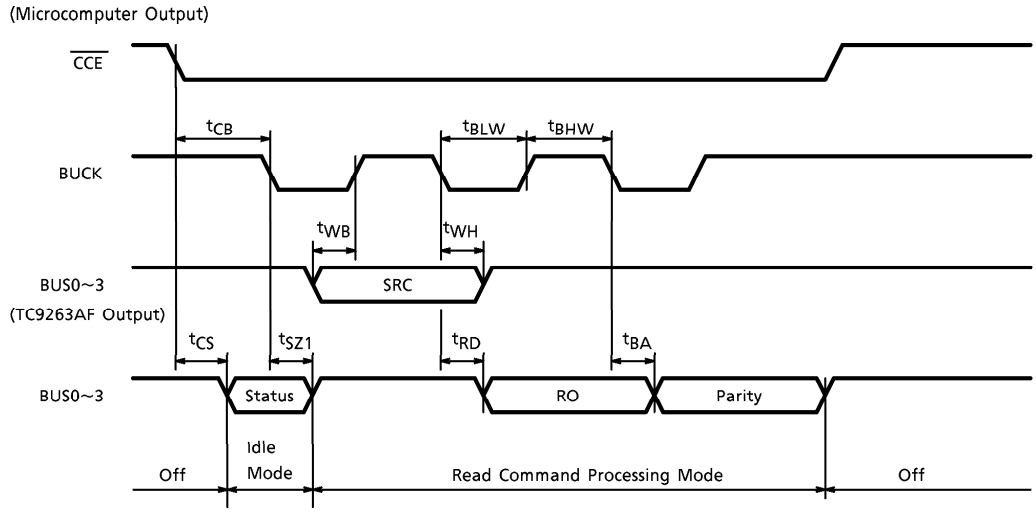
(2) Microcomputer interface timing

CHARACTERISTIC		SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Clock Pulse Width (1)	"H" Level	t_{BHW}	BUCK	10	—	—	μs
	"L" Level	t_{BLW}		10	—	—	
Clock Pulse Width (2)		t_{CC}	$\overline{CCE}$	6	—	—	
Delay Time (1)		t_{CB}	$\overline{CCE}$→BUCK	—	—	6	μs
Delay Time (2)		t_{WB}	Command Data→BUCK	0	—	—	
Delay Time (3)		t_{CS}	$\overline{CCE}$→Status Output	—	—	6	
Set-Up Time (1)		t_{RD}	BUCK→Read Data Output	—	—	6	μs
Set-Up Time (2)		t_{BA}	BUCK→ACK, Parity Output	—	—	6	
Hold Time (1)		t_{SZ1}	BUCK→ACK, Parity, Status Output	—	—	6	μs
Hold Time (2)		t_{SZ2}	$\overline{CCE}$→Status Output	—	—	6	
Hold Time (3)		t_{WH}	BUCK→Command Data	6	—	—	

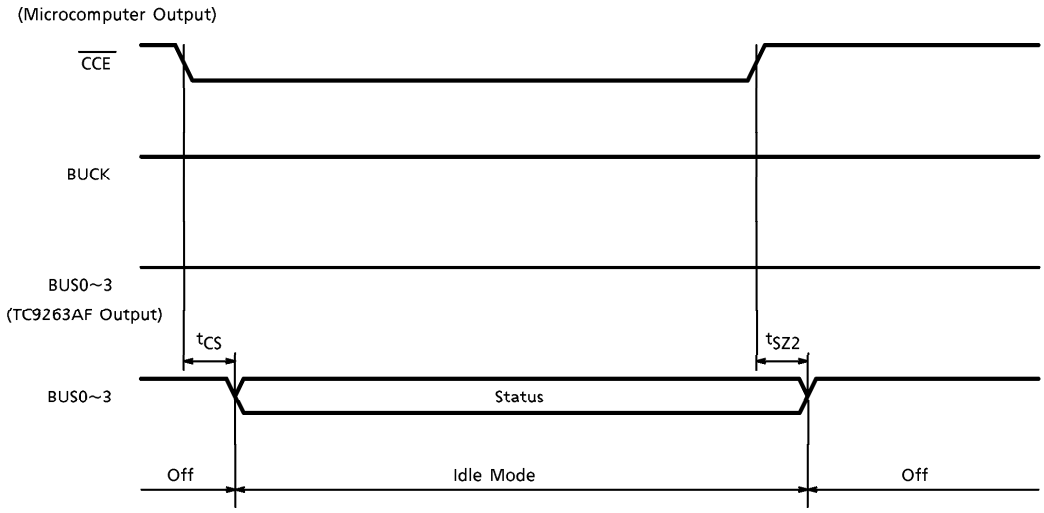
(a) Write command processing mode



(b) Read command processing mode

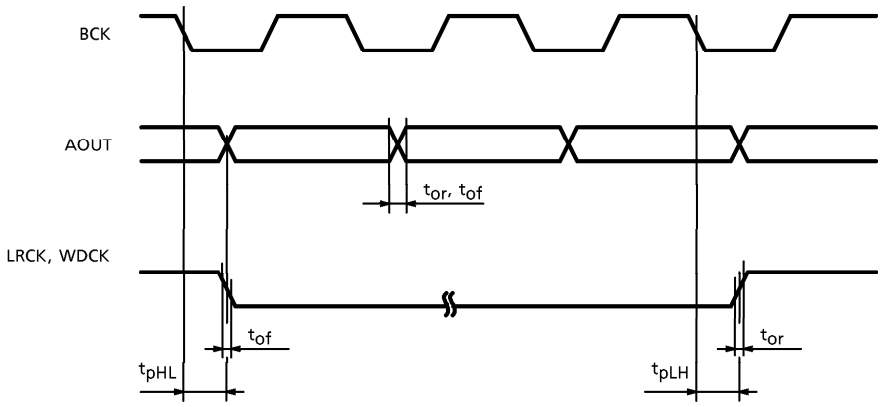


(c) Idle mode



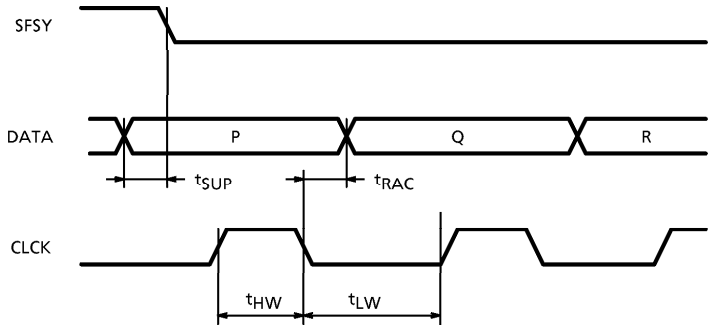
(3) Data output system timing

CHARACTERISTIC		SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Transfer Time	"H" Level	t_{pHL}	BCK→AOUT, WDCK, LRCK	—	—	30	ns
	"L" Level	t_{pLH}		—	—	30	
Output Rising Time		t_{or}	AOUT, WDCK, LRCK	—	—	15	ns
Output Falling Time		t_{of}		—	—	15	



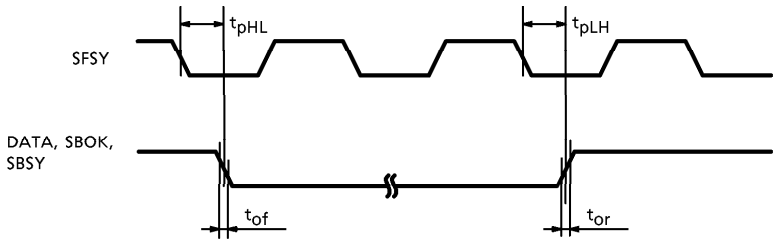
(4) Output timing for subcode P~W

CHARACTERISTIC		SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Clock Pulse Width	"H" Level	t_{HW}	CLCK	2	—	—	ns
	"L" Level	t_{LW}		2	—	—	
Set-Up Time		t_{SUP}	SFSY→DATA	0.4	—	—	ns
Read Access Time		t_{RAC}	CLCK→DATA	1.2	—	—	



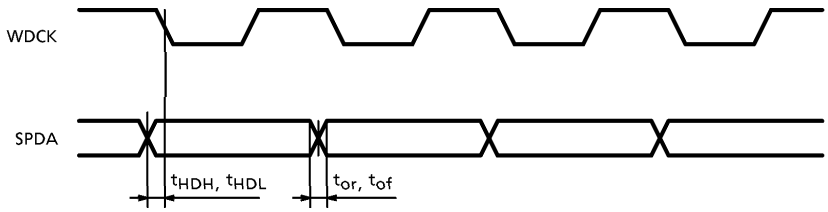
(5) Output time for subcode Q

CHARACTERISTIC		SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Transfer Time	"H" Level	t_{pHL}	SFSY→SBOK, SBSY	−50	—	200	ns
	"L" Level	t_{pLH}		−50	—	200	
Output Rising Time		t_{or}	SBOK, SBSY	—	—	40	ns
Output Falling Time		t_{of}		—	—	40	



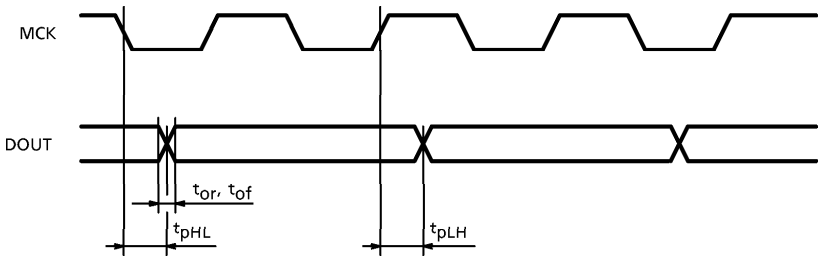
(6) Status signal output timing

CHARACTERISTIC		SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Hold Time	"H" Level	t_{HDH}	WDCK→SPDA	—	—	200	ns
	"L" Level	t_{HDL}		—	—	200	
Output Rising Time		t_{or}	SPDA	—	—	40	ns
Output Falling Time		t_{of}		—	—	40	



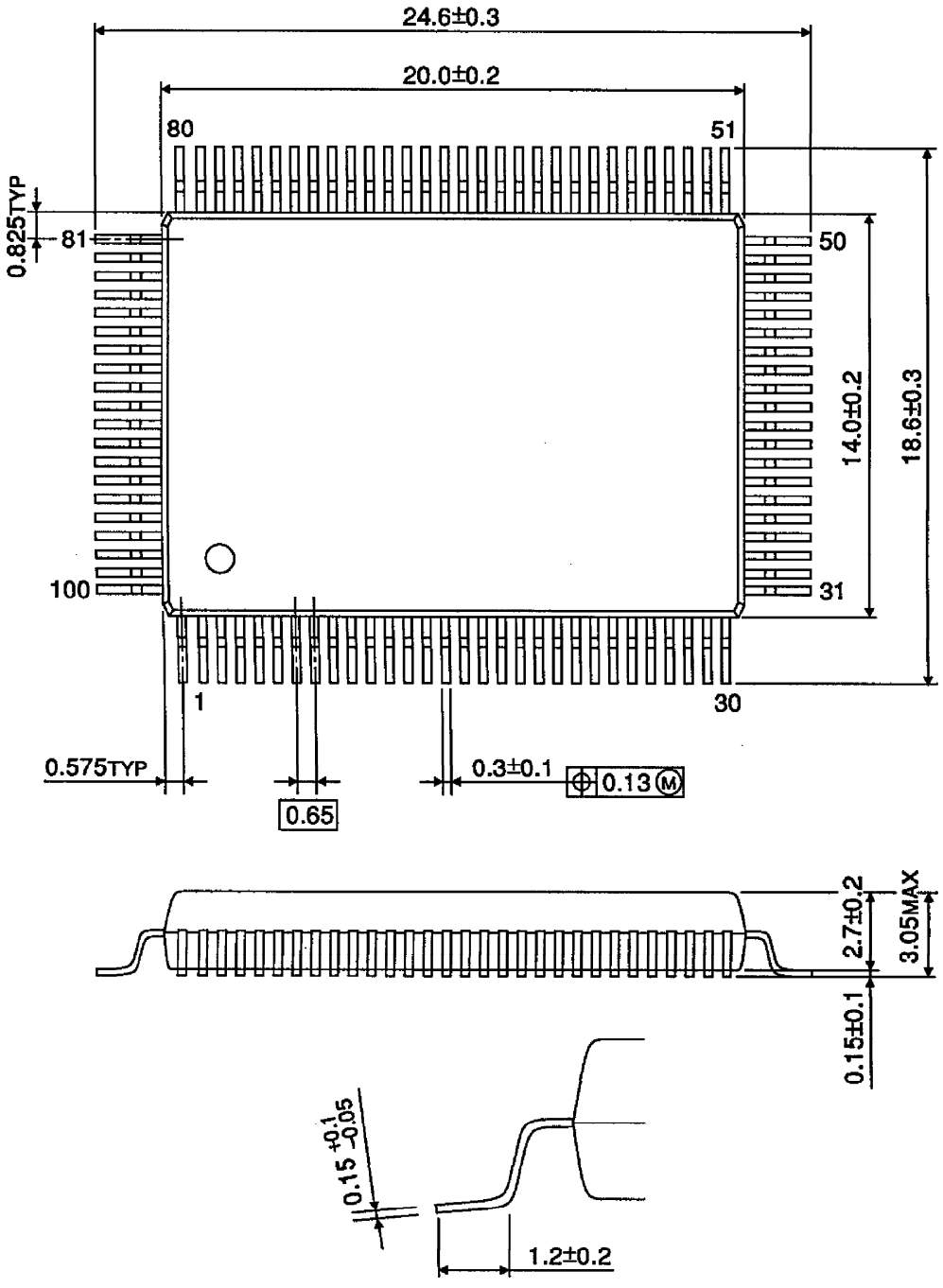
(7) Digital output timing

CHARACTERISTIC		SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Transfer Time	"H" Level	t_{pHL}	MCK→DOUT	—	—	60	ns
	"L" Level	t_{pLH}		—	—	60	
Output Rising Time		t_{or}	DOUT	—	—	14	ns
Output Falling Time		t_{of}		—	—	14	



OUTLINE DRAWING

QFP100-P-1420-0.65 Unit : mm



Weight : 1.6g (Typ.)